

HIGH RESOLUTION, HIGH ENERGY and HIGH SPEED

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OUTLINE

1. Introduction
2. State of the art: High-resolution detector at ESRF
3. Detector for high resolution and high energy
4. FRELON camera for high frame rate
5. Performance
6. Further developments



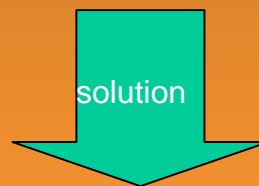
INTRODUCTION

- REQUEST for detector

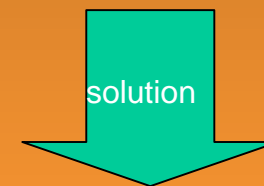
Microstructure evolving in few minutes

- High spatial resolution: a few μm ? small FOV
- DR: 12 bit minimum
- High energy (white beam, peak at 65keV)
- 500 images to be acquired in 30 seconds ? 16 fps minimum

- PROBLEMS RADIATION DAMAGE FAST IMAGING SYSTEM



Mirror objective



FRELON CCD camera

HIGH-RESOLUTION DETECTOR

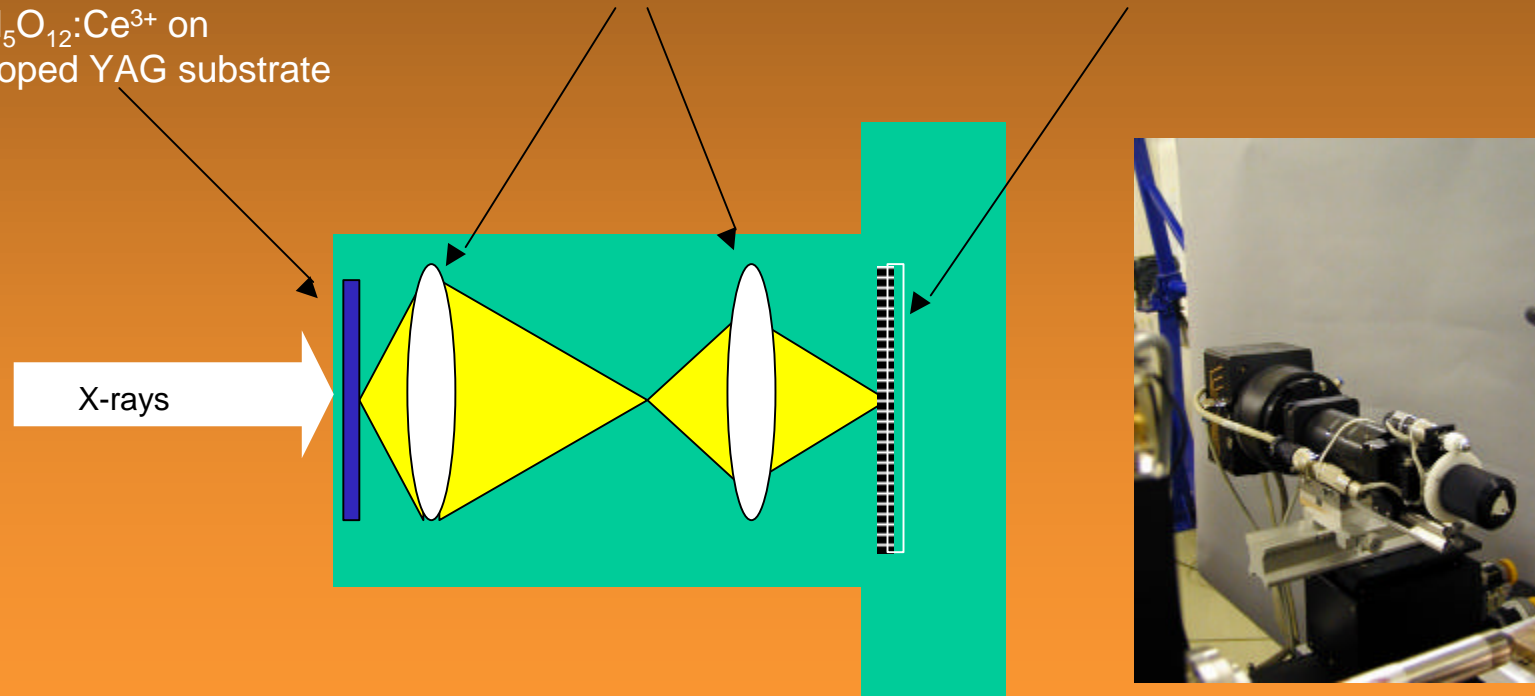
State of the Art

IN-LINE DETECTOR For Low Energy

PRINCIPLE:

LUMINESCENT SCREEN + OPTICAL MICROSCOPE + CCD DETECTOR

$\text{Y}_3\text{Al}_5\text{O}_{12}:\text{Ce}^{3+}$ on
170 μm undoped YAG substrate

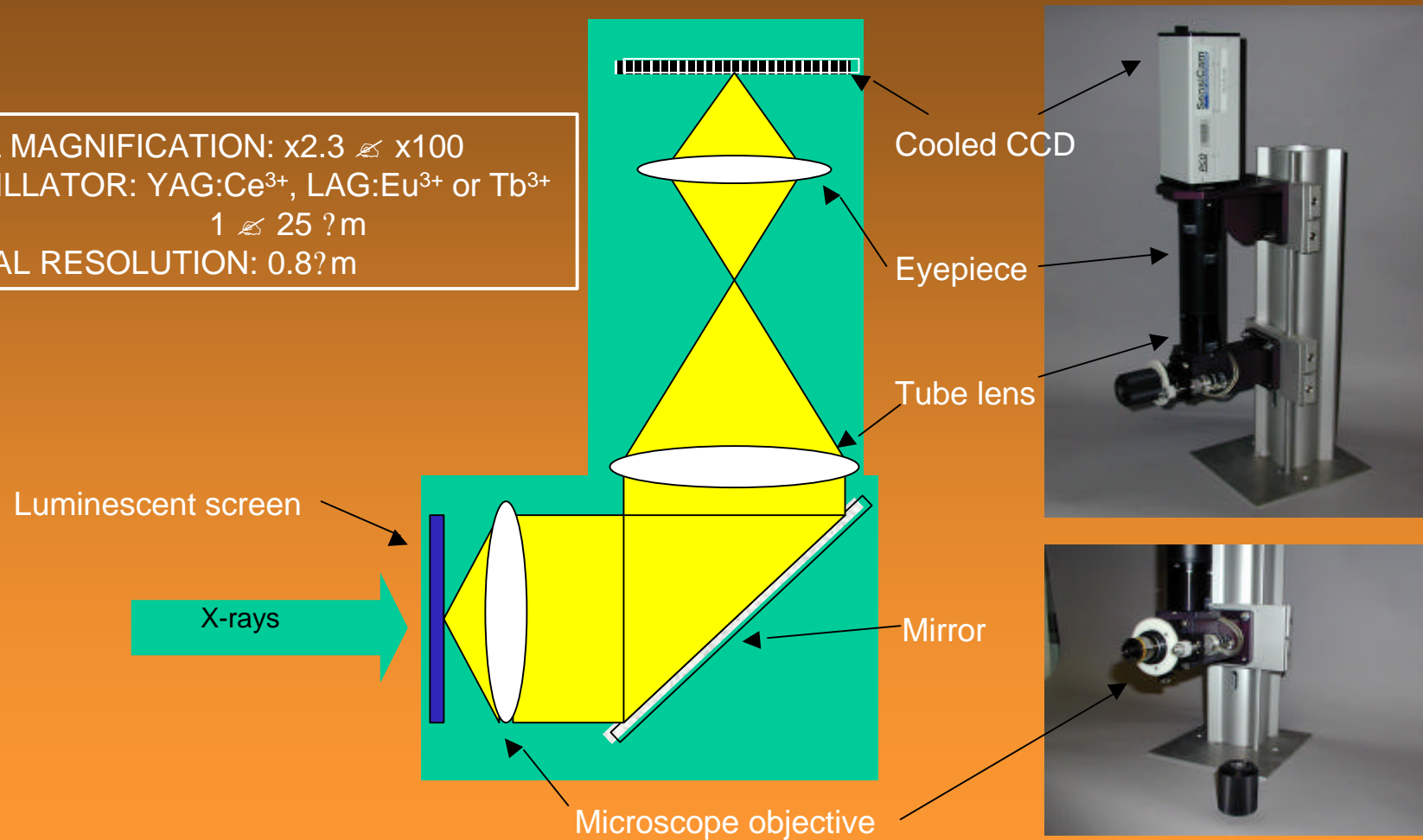


HIGH-RESOLUTION DETECTOR

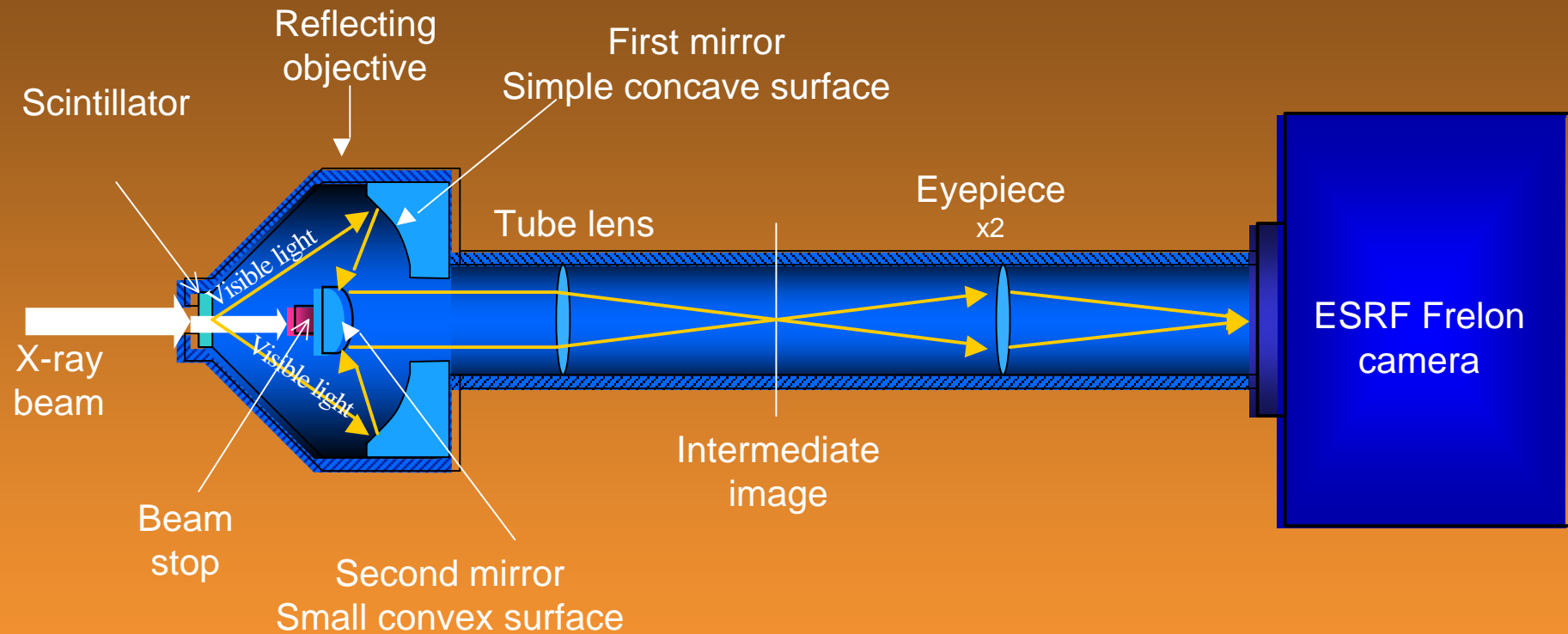
State of the Art

FOLDED DETECTOR For Low Energy

- TOTAL MAGNIFICATION: $x2.3 \times x100$
- SCINTILLATOR: YAG:Ce³⁺, LAG:Eu³⁺ or Tb³⁺
1 \times 25 μ m
- SPATIAL RESOLUTION: 0.8 μ m



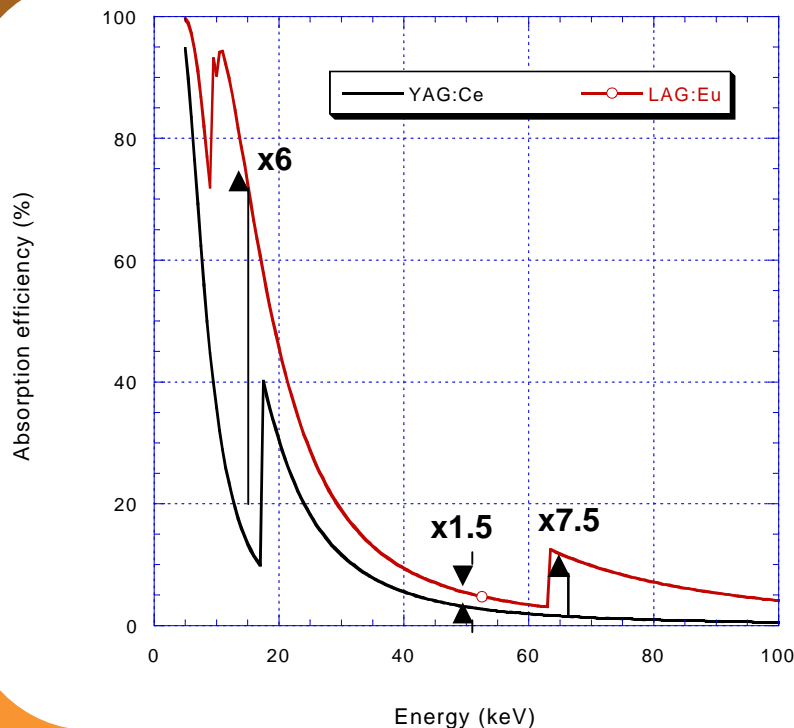
HIGH-RESOLUTION DETECTOR FOR HIGH ENERGIES



SCINTILLATOR

Its 4 main characteristics are:

- Absorption coefficient: $\sim Z_{\text{eff}}^4 \times ?$
- Light yield depends on activator and its concentration
- Spectral response must be matched with QE of CCD
- Afterglow depends on exposure time and activator concentration



YAG:Ce³⁺

$x = 25? \text{ m}$

$? = 4.55 \text{ g/cm}^3$

$Z_{\text{eff}} = 32$

$?_{x/?} = 0.06$

LAG:Eu³⁺

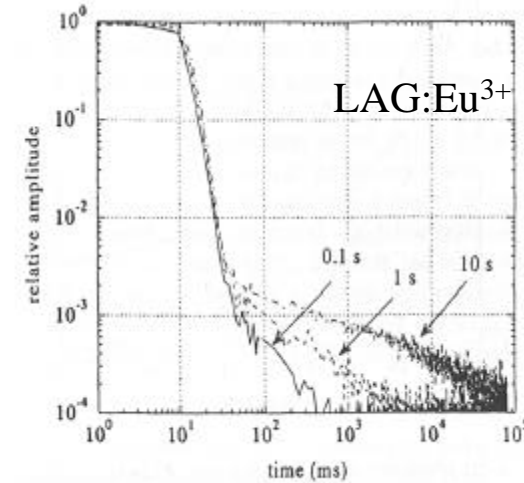
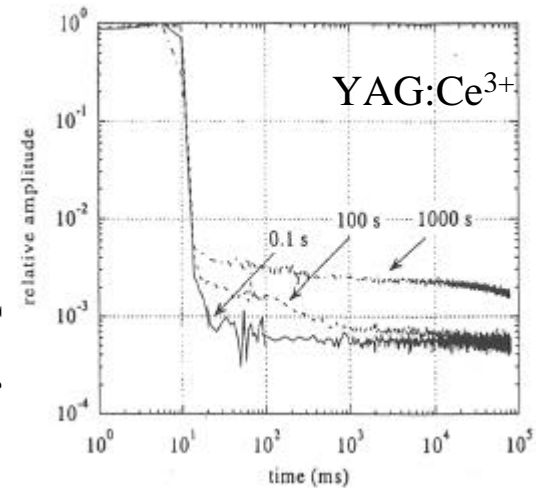
$x = 25? \text{ m}$

$? = 6.6 \text{ g/cm}^3$

$Z_{\text{eff}} = 63$

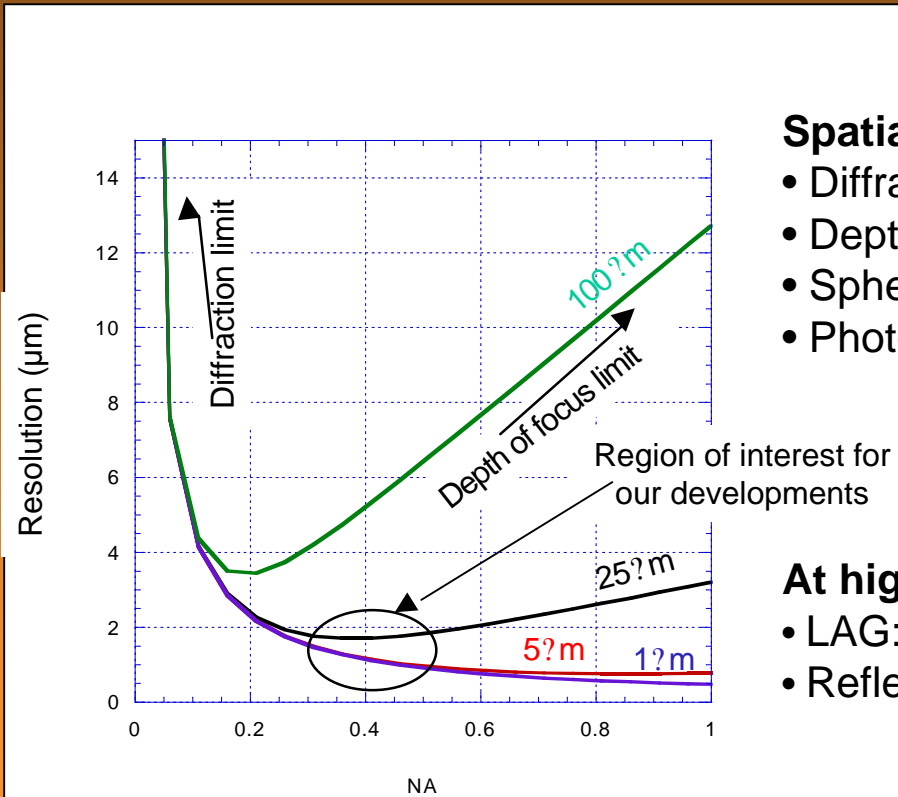
$?_{x/?} = 0.03$

Afterglow after different X-ray exposure times



X-RAY IMAGING with SCINTILLATOR

Limits of resolution



Spatial resolution is limited by

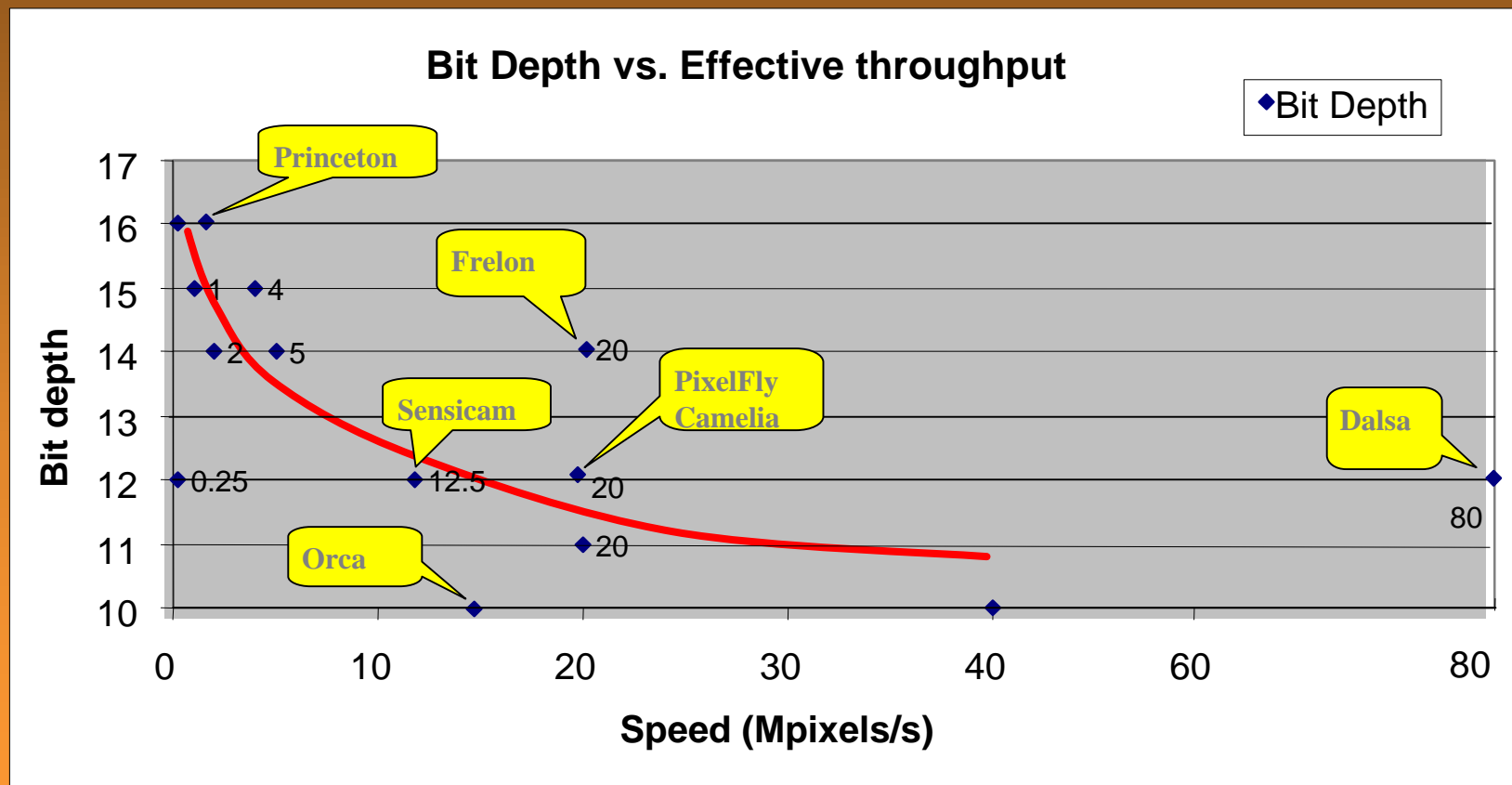
- Diffraction: $R \sim \lambda / NA$
- Depth of focus: $R \sim z \cdot NA$
- Spherical aberrations of substrate: $R \sim t \cdot NA^3$
- Photoelectron range

At high energy, we use

- LAG:Eu³⁺ scintillator 6 μm to 25 μm
- Reflecting objective x15 NA=0.5 (Ealing)
x5 NA=0.2 (Nachet)

CHOICE OF CAMERA

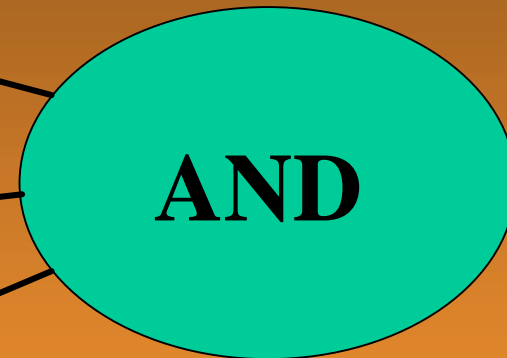
FReLoN camera on the market



The FReLoN PROJECT

Main Features

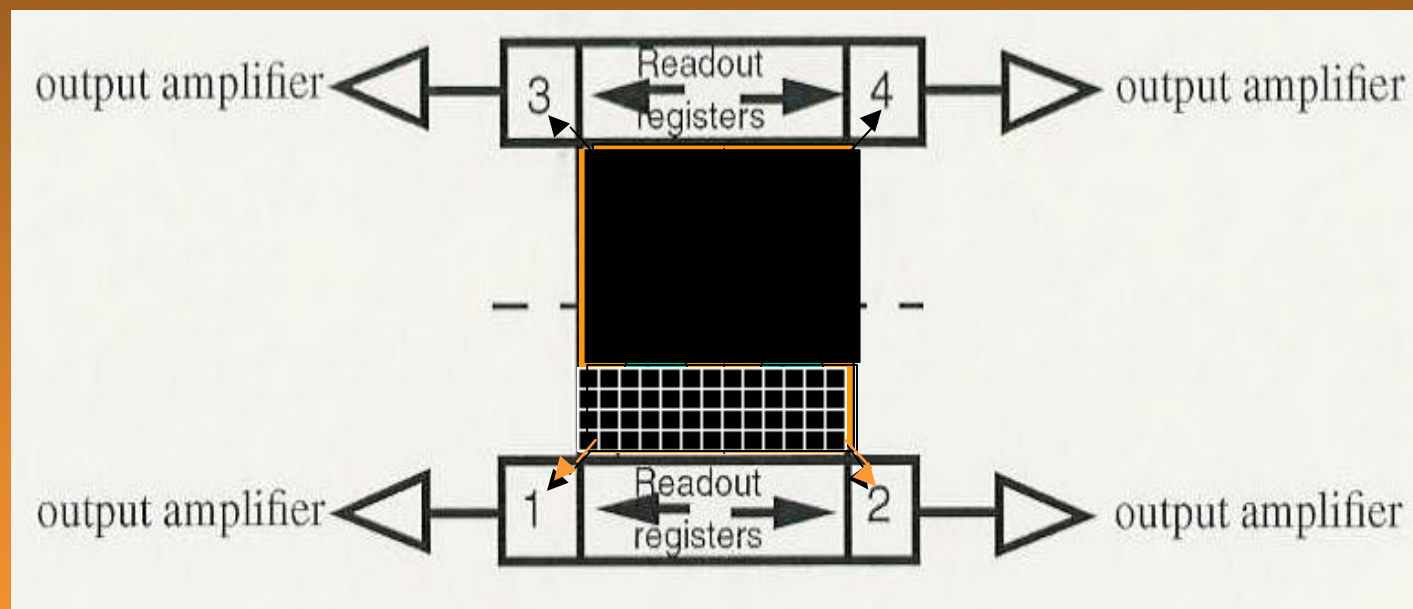
- High pixel rate
 - 20 Mpls/s throughput
- Low noise readout
 - 25 e⁻
- Dynamic range
 - DR= 14 bit



The FReLoN PROJECT

Block diagram

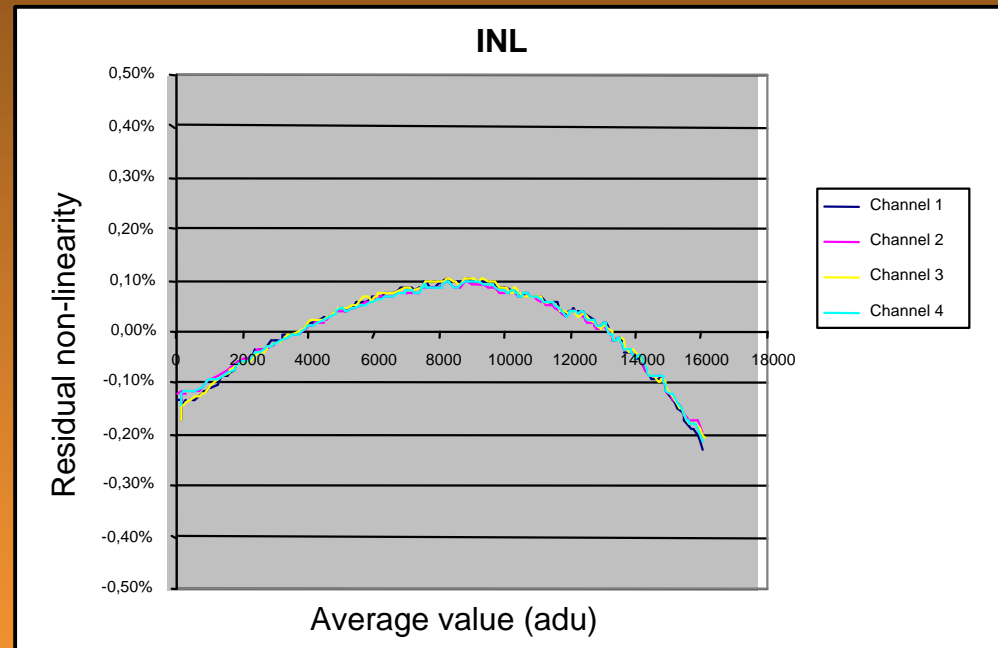
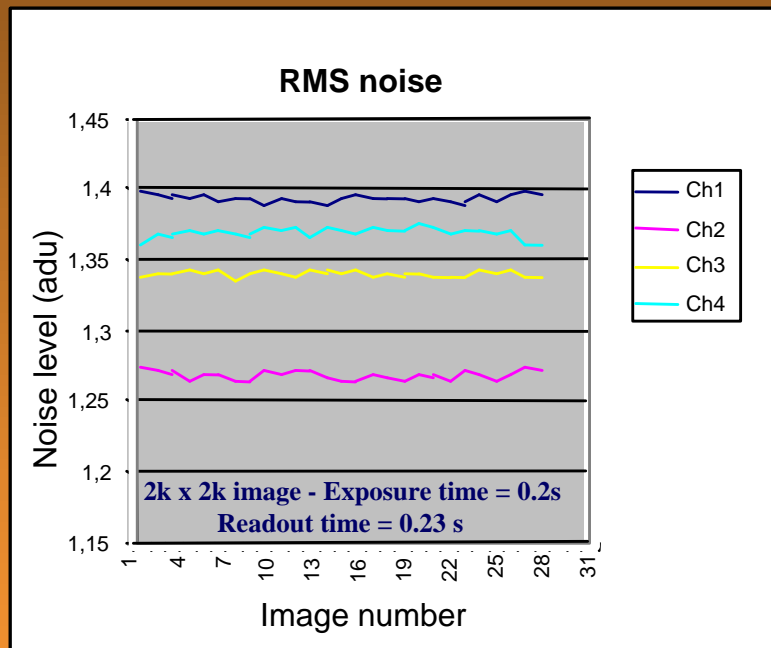
Parallel Readout AND Low Noise AND High Speed



kinetic pipeline mode

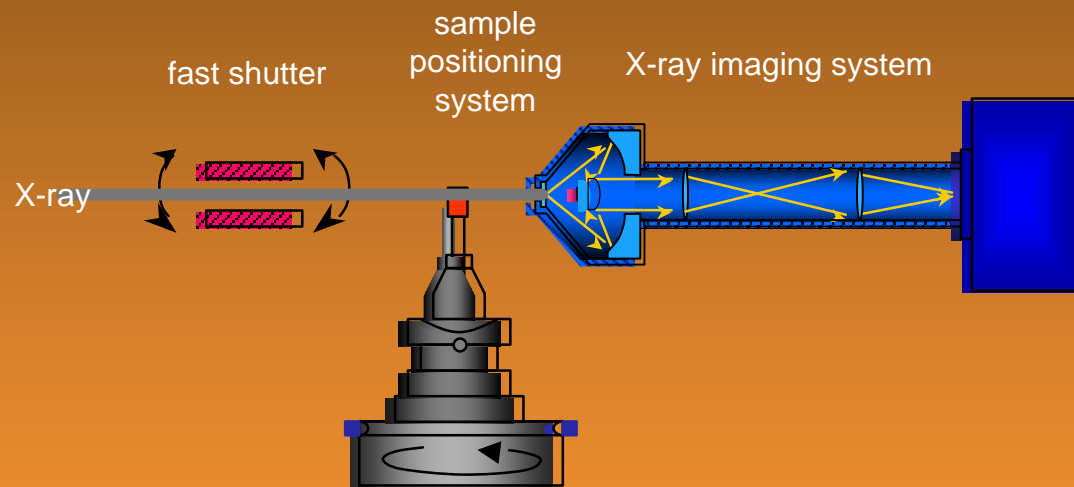
FReLoN

Noise and Integral Non-Linearity



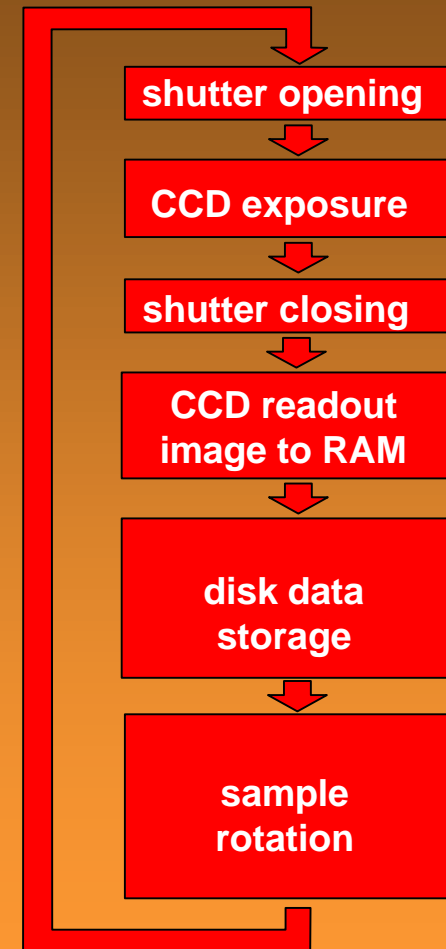
High resolution, high energy and high speed system

Application



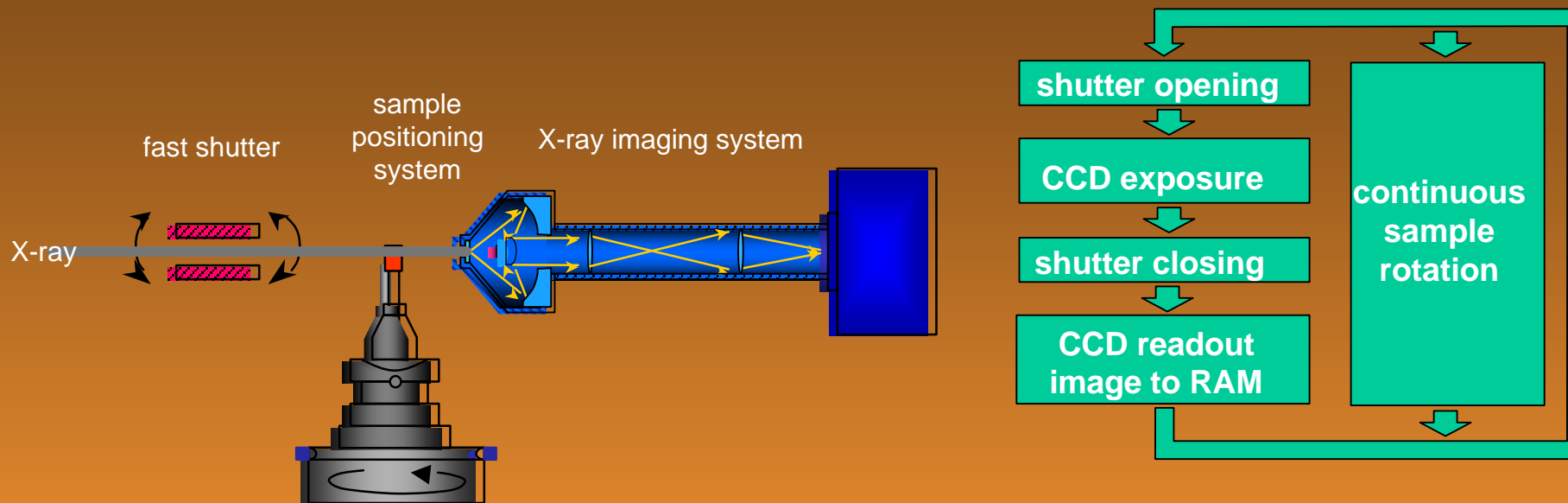
Typical acquisition

9 minutes



High resolution, high energy and high speed system

Application

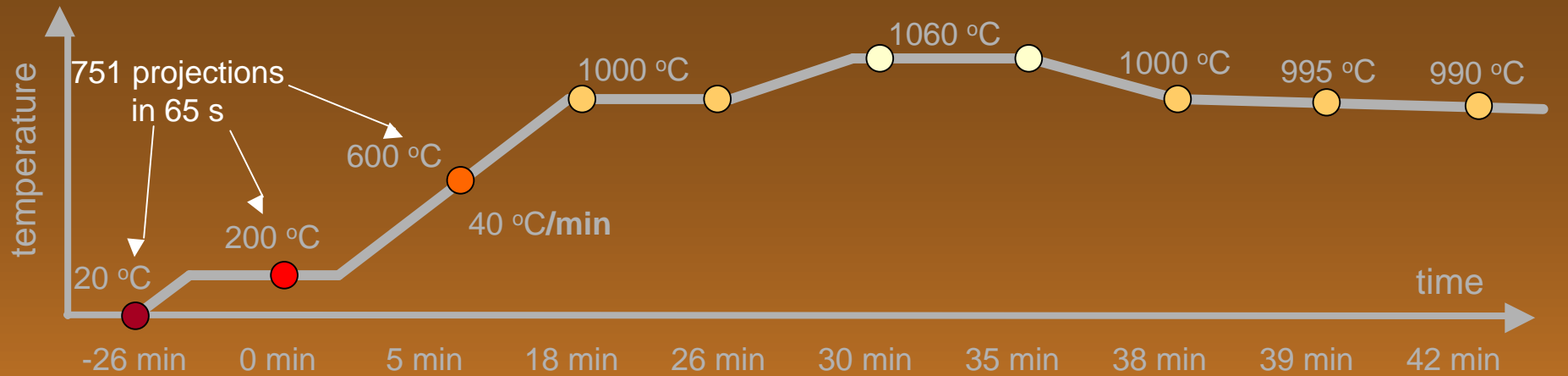


Typical acquisition time with kinetic pipeline mode

	Binning	CCD+Exposure(45ms)	Time for 1000 frames
2048 x 128	no	13.6fps	73sec
2048 x 256	no	9.7fps	104sec
2048 x 256	2x2	13.3fps	75sec

APPLICATION

Microstructure evolution during sintering process (copper particles)



0 min

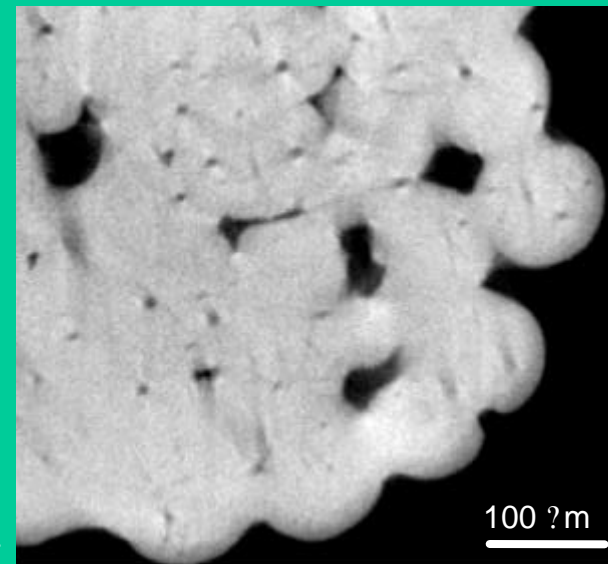
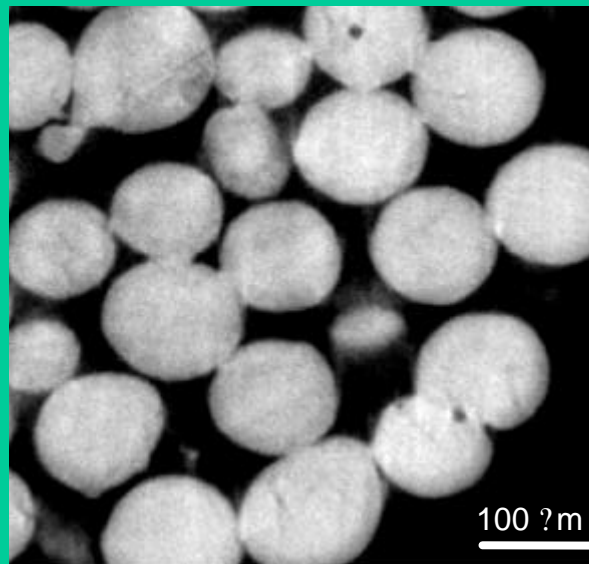
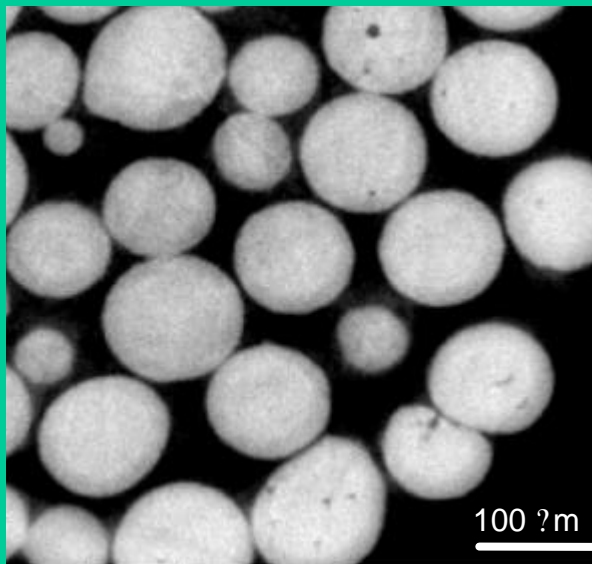
200 °C

26 min

1000 °C

38 min

1000 °C



7510 projections – Frelon 2K – no binning – exposure time 40 ms – ROI 1024 x 128 – LAG 1 μm – magnification x 9

PERFORMANCE

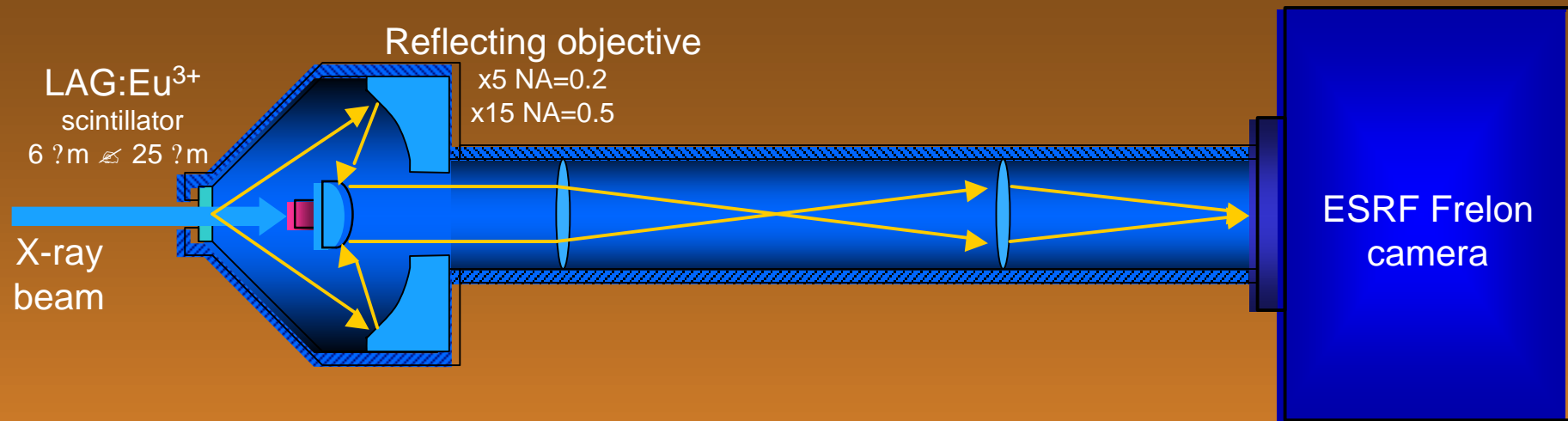
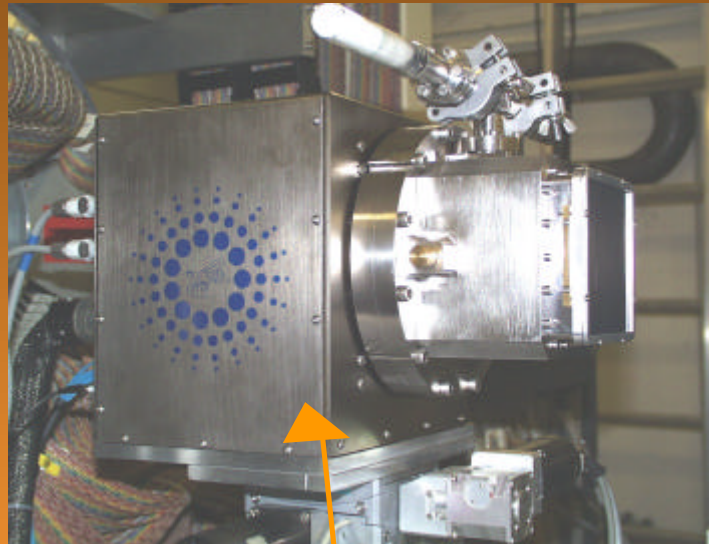


Image depth: 14 bit
 Pixel size: 14 x 14 μm²
 ADC unit: 20 e⁻
 Read-out noise: 25 e⁻
 Frame rate 2kx2k: 5 fps
 10 fps (2x2 binning)

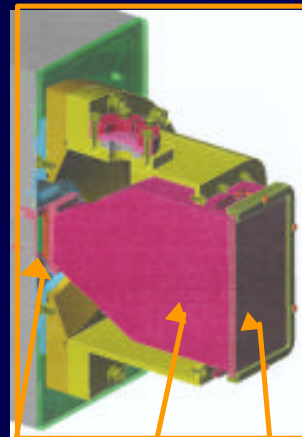
Input pixel size: 0.47 μm or 1.4 μm
 Field of view: 1x1 mm² or 2.9x2.9 mm²
 Number of pixels: 2048 x 2048
 Spatial resolution: 4 μm @ 65keV
 DQE (6 μm LAG, 65keV): 2.5%, mainly limited by absorption

FReLoN

Other applications: CCD camera with taper optic
Used at ID17



FRELON camera



CCD with Peltier stage

Taper

fluorescent screen

For more information,

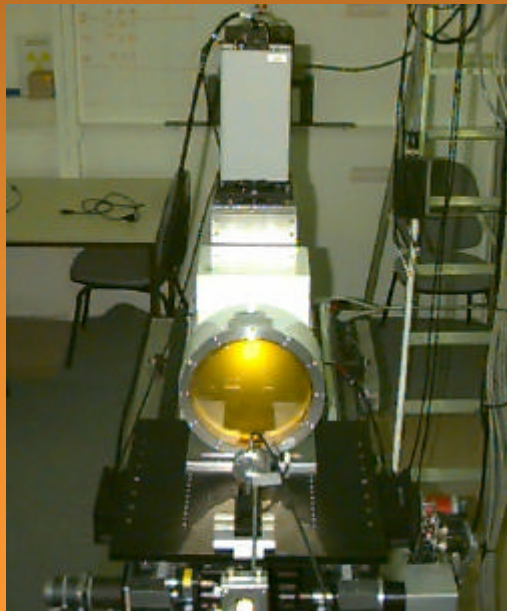
see Poster

- ✎ Based on low noise, fast readout FReLoN system
- ✎ Tapered fiber optical coupling
- ✎ Exchangeable mammography phosphor screens
- ✎ Vitreous carbon window
- ✎ Full frame or continuous line-by-line readout
- ✎ 2000 x 2000 pixels
- ✎ 50 x 50 micron² input pixel size
- ✎ 93 x 93 mm² X-ray sensitive area
- ✎ 14bit dynamic range
- ✎ Spatial resolution: 110 μ m LSF FWHM with MR detail HD-S phosphor screen @ 18keV

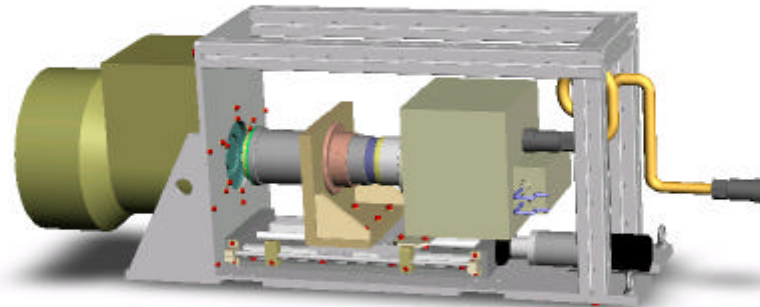
FReLoN

Other applications: FReLoN coupled to image intensifier

For more information,
see Poster



**Developed for PX, SAXS, WAXS,
materials diffraction**
Used at ID2 (2 systems), ID11 and ID15



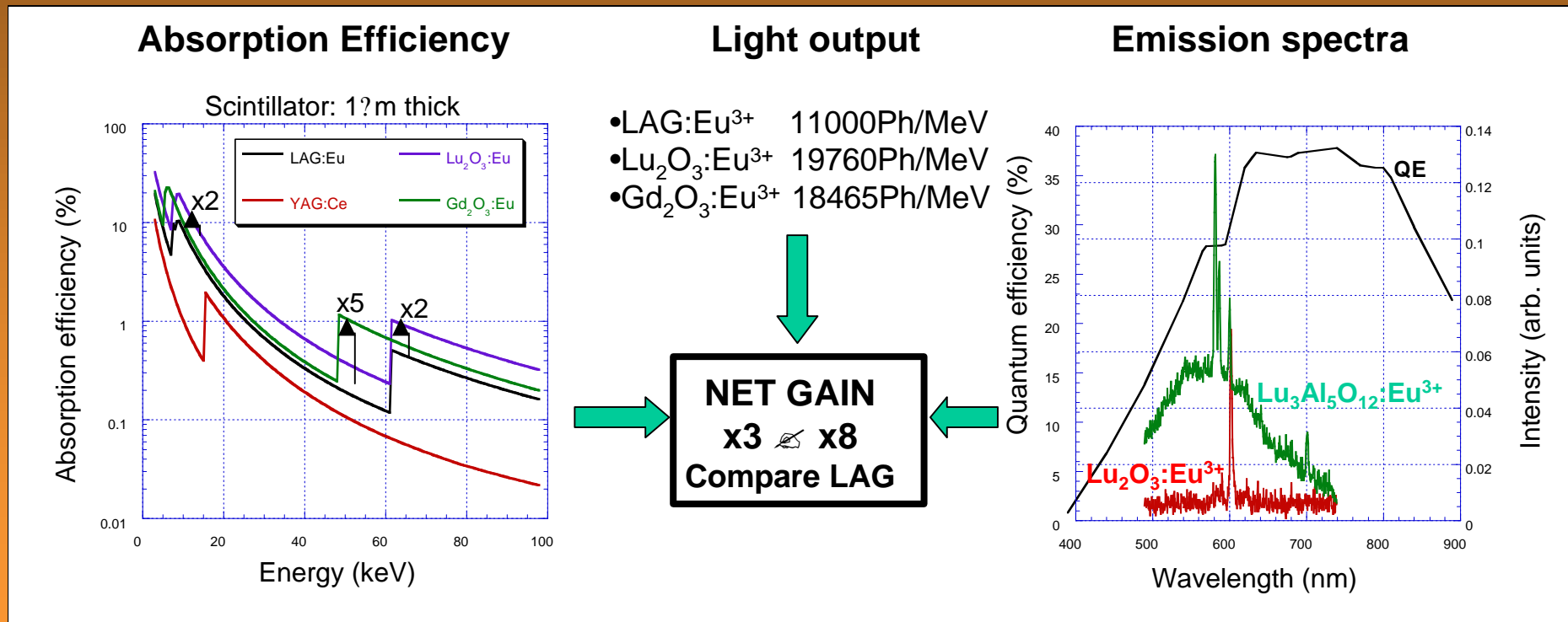
Characteristics with **FReLoN 2kx2k 14 bit:**

Detection area :	210 mm diagonal
Energy range :	5-30 keV (Be input window)
Spatial resolution :	200-300 μm LSF FWHM
DQE :	? 0.6 @ 8 keV
Noise :	? 5-10 keV/pixel r.m.s.
Readout time :	< 100 ms in 2x2 binning

FURTHER DEVELOPMENTS

SCINTILLATOR $\text{Lu}_2\text{O}_3:\text{Eu}^{3+}$ and $\text{Gd}_2\text{O}_3:\text{Eu}^{3+}$

1. Improves absorption
2. Improves light yield
3. Non-luminescent substrate



SCINTILLATOR

Choice of fabrication process



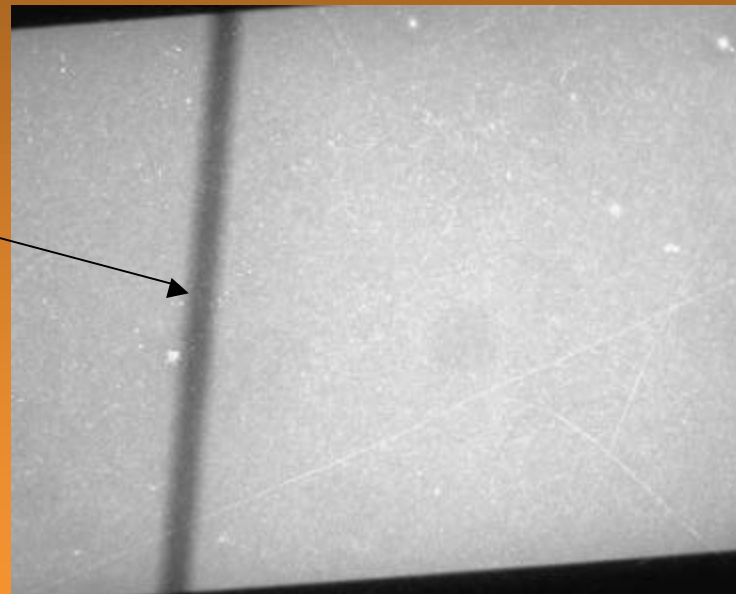
Sol-gel process

- Making of very pure oxide film
- High-density film and good optical quality
- Homogeneous doping at molecular scale
- Possibility to deposit on large area
- Shape and kind of substrate
- Price

SCINTILLATOR

W wire image with 800nm $\text{Gd}_2\text{O}_3:\text{Eu}^{3+}$ scintillator thickness

W wire: ? 30?m



X-ray generator with Cu anode, 30kV, 40mA.
Field of view: 1.4 x 1.1 mm².

CONCLUSION

- High resolution and high energy and high speed
 - $R = 4\text{?m}$ fwhm with white beam, peak at 65keV
 - 751 images in 65s
- Scintillator
 - Encouraging result with 800nm $\text{Gd}_2\text{O}_3:\text{Eu}^{3+}$ scintillator
 - ? Beam position Monitoring
 - Thicker $\text{Lu}_2\text{O}_3:\text{Eu}^{3+}$ and $\text{Gd}_2\text{O}_3:\text{Eu}^{3+}$ scintillator
- New x10 reflecting objective (compromise between magnification and NA, reduced obscuration)
- 2nd FReLoN generation
 - FReLoN 16bit
 - Frame transfer mode
 - Fast readout board ? Extended to non-FreLoN camera, like Dalsa camera (60fps)

Staff involved in Project

- ATEG Group (ESRF) for Frelon: J.C. Labiche, E. Collet, L. Siron and D. VanBrussel
- Special Detectors Group (ESRF): T. Martin, J. Borrel, C. Jarnias, F. Lesimple and C. Ponchut
- BLISS group (ESRF): D. Fernandez, G. Berruyer and V. Rey
- ID15 Beamline (ESRF): M. Di Michiel, T. Buslaps, J.M. Merino, V. Honkimaki
- Laboratoire de Physico-Chimie des Matériaux Luminescents, University of Lyons, France. C. Dujardin, A. Garcia-Murillo and C. Leluyer

